

Carrier Material Report for TMS320C6424ZDUQ6

Tray Information:



Device	Package Drawing	Package Type	Pins	SPQ	Unit Array Matrix	Max Temp (°C)	L (mm)	W (mm)	K0 (μm)	P1 (mm)	CL (mm)	CW (mm)
TMS320C6424ZDUQ6	ZDU	BGA	376	60	5 X 12	150	315	135.9	7620	25.5	17.25	16.95

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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